

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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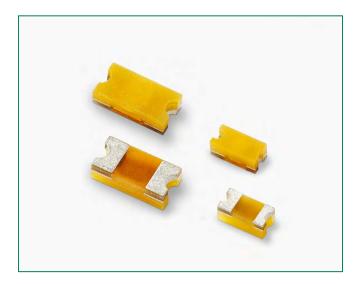






XGD Series





Equivalent Circuits

0402 and 0603 Devices



Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

Product Characteristics

Part Number	Lines Protected	Component Package	Available as Halogen-Free
XGD10402	1	0402	Yes
XGD10603	1	0603	Yes

Description

XTREME-GUARD™ ESD Suppressors protect sensitive electronic equipment against extreme ESD conditions, in very small 0402 and 0603 footprints. This series product is specifically designed to suppress fast-rising ESD transients up to 30kV while adding virtually no capacitance to the circuit, which helps preserve signal integrity and minimize data loss. It is a RoHS compliant, halogen free, and Pb free and Pb free ESD Suppressor.

Features

- High ESD Rating up to 30kV Contact/Air Discharge
- RoHS compliant, lead-free and halogen-free
- Ultra-low capacitance
- Low leakage current
- Fast response time
- Bi-directional
- Withstands multiple ESD strikes

- Compatible with pick-and-place processes
- Available in 1000, 5000, and 10000 piece reels (EIA-RS481)
- High rated voltage up to 32V maximum
- High operating temperature at 125°C

Applications

- Wearable Devices
- Notebooks/Laptops/PCs
- Gaming Consoles
- Smart TVs
- Smart Phones
- Tablets

- Set Top Boxes
- Networking and Wireless Hardware
- Stationary and Portable Medical Devices

Electrical Characteristics

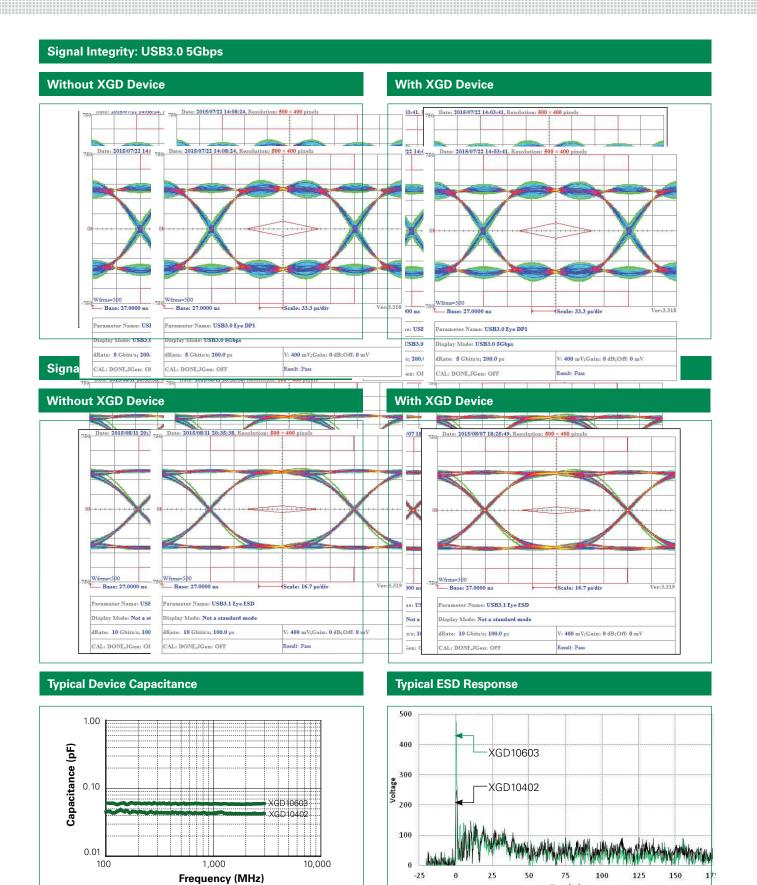
Specification	XGD10402	XGD10603	Notes
ESD Capability: IEC 61000-4-2 Contact Discharge (typical) IEC 61000-4-2 Air Discharge (typical)	30kV 30kV	30kV 30kV	The ESD capability measured by direct and air discharge method is subject to testing equipment and conditions. Numerous factors could affect the reliability and reproducibility of the direct and air discharge test results.
Trigger Voltage (typical) Clamping Voltage (typical)	250V 40V	400V 40V	Measured per IEC 61000-4-2 8kV Direct Discharge Method
Trigger Voltage (typical) Clamping Voltage (typical)	150V 40V	300V 28V	Measured using 500V TLP Direct Discharge Method
Rated Voltage (maximum)	24V max	32V max	
Capacitance (typical)	0.04 pF	0.09 pF	Measured at 250MHz
Response Time	<1nS	<1nS	
Leakage Current (typical)	<1nA @24V	<1nA @24V	
ESD Pulse Withstand	1000 pulses min	1000 pulses min	Some shifting in characteristics may occur when tested over multiple pulses at a very rapid rate

Note: Testing performed on Littelfuse test setup as described in Typical Test Setup Section on page 4 of this document.

Specifications are subject to change without notice.

XTREME-GUARD™ ESD Suppressors

Surface Mount Polymeric Electrostatic Discharge Suppressors



XTREME-GUARD™ ESD Suppressors Surface Mount Polymeric Electrostatic Discharge Suppressors



Physical Specifications

Materials	Body: Glass Epoxy Terminations: Copper/Nickel/Tin	
Solderability	MIL-STD-202, Method 208	
Soldering Parameters	Wave solder - 260°C, 10 seconds maximum Reflow solder - 260°C, 30 seconds maximum	

Design Consideration

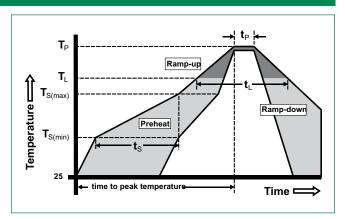
Because of the fast rise-time of the ESD transient, proper placement of XTREME-GUARD™ suppressors are a key design consideration to achieving optimal ESD suppression. The devices should be placed on the circuit board as close to the source of the ESD transient as possible. Install XTREME-GUARD™ suppressors (connected from signal/data line to ground) directly behind the connector so that they are the first board-level circuit component encountered by the ESD transient.

Environmental Specifications

Operating and Storage Temperature	-65°C to +125°C	
Moisture Resistance	0402 and 0603 series: 85°C, 85% RH, 1000 hours 40°C, 95% RH, 1000 hours	
Thermal Shock	MIL-STD-202, Method 107, -65°C to 125°C, 30 min. cycle, 10 cycles	
Vibration	MIL-STD-202, Method 201, (10 to 55 to 10 Hz, 1 min. cycle, 2 hrs each in X-Y-Z)	
Chemical Resistance	MIL-STD-202, Method 215	

Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	-Temperature Min (T _{s(min)})	150°C
	-Temperature Max (T _{s(max)})	200°C
	-Time (min to max) (t _s)	60 – 180 seconds
Average ramp up rate (Liquidus Temp (T_L) to peak		3°C/second max
T _{S(max)} to T _L	- Ramp-up Rate	3°C/second max
Reflow	-Temperature (T _L) (Liquidus)	217°C
nellow	-Temperature (t _L)	60 – 150 seconds
PeakTemp	perature (T _P)	260°C
Time within 5°C of actual peak Temperature (t _p)		10 – 30 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peakTemperature (T _P)		8 minutes max



Based on IPC/JEDEC J-STD-020

Packaging

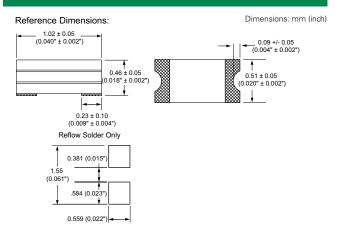
Part Number	Quantity & Packaging Code	Quantity	Packaging Option	Packaging Specification
XGD10402	KR	10000	Tape & Reel (7" reel)	EIA RS-481-1 (IEC 286, part 3)
XGD10603	MR	1000	Tape & Reel (7" reel)	EIA RS-481-1 (IEC 286, part 3)
XGD10603	NR	5000	Tape & Reel (7" reel)	EIA RS-481-1 (IEC 286, part 3)

XTREME-GUARD™ ESD Suppressors

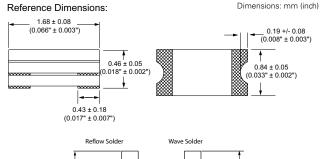
Surface Mount Polymeric Electrostatic Discharge Suppressors

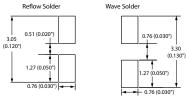
Dimensions

0402 Device



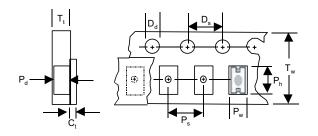
0603 Device





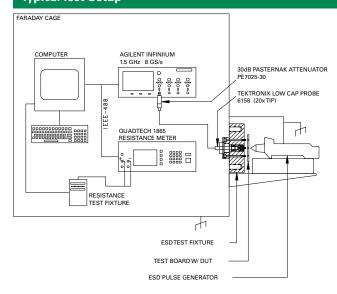
Tape and Reel Specifications

Recommended Pad Layout



Description	0402 Series (mm)	0603 Series (mm)
C _t - Cover tape thickness	0.05	0.05
D _d - Drive hole diameter	1.50	1.50
D _s - Drive hole spacing	4.00	4.00
P _d - Pocket depth	0.56	0.58
P _h - Pocket height	1.14	1.85
P _s - Pocket spacing	2.00	4.00
P _w - Pocket width	0.62	1.02
T _t - Carrier tape thickness	0.65	0.65
T _w - Carrier tape width	8.00	8.00

Typical Test Setup



Part Numbering System

